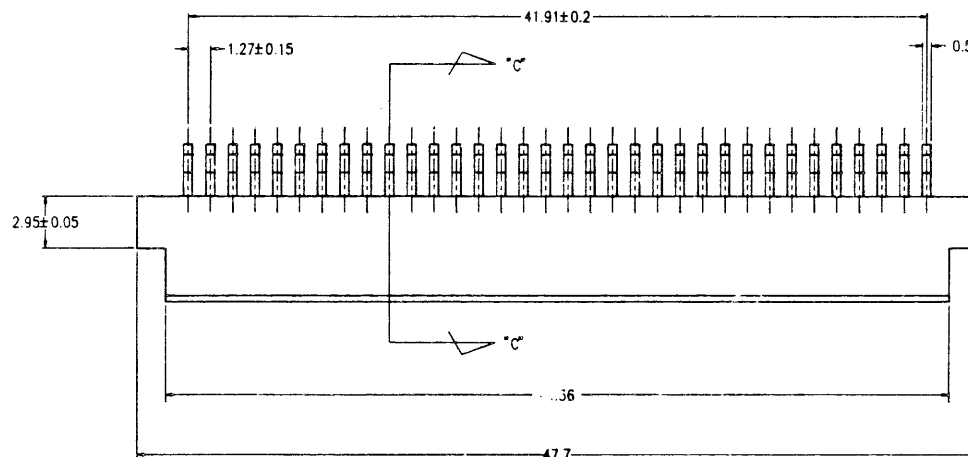
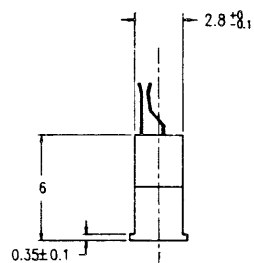


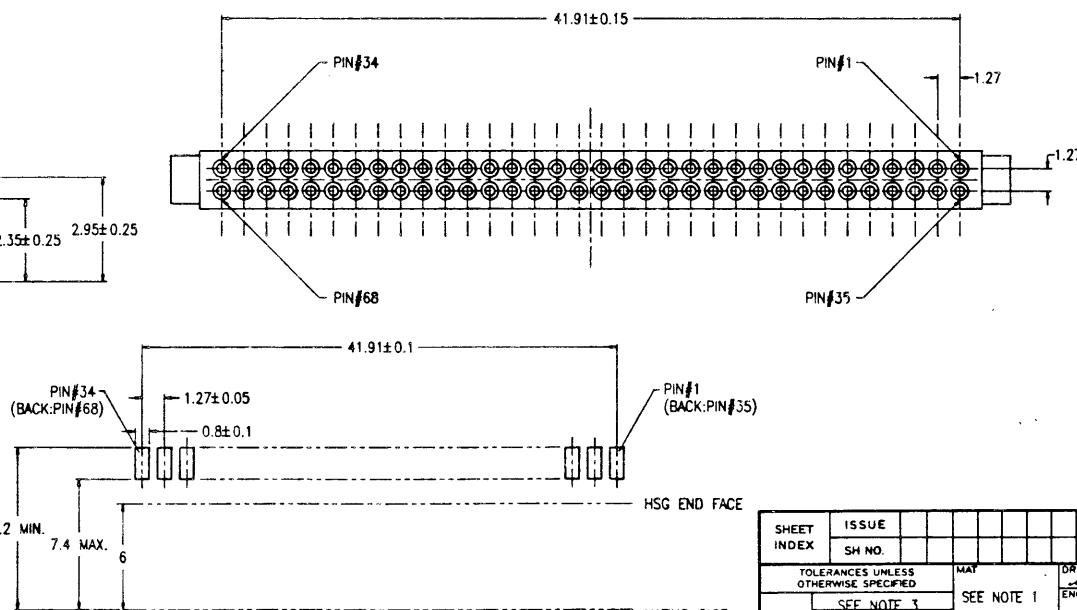
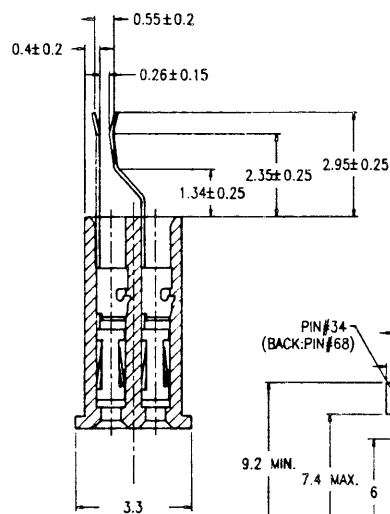
PRODUCT No.	PLUG HSG COLOR
90936-003	BLACK

REVISIONS				
REV	DESCRIPTION	ECN	BY	DATE
A	RELEASED	J20031	WK	2/7/92
B	REVISED(HSG MATERIAL)	J20210	KS	2/7/93
C	REVISED	J40024	KS	2/25/94



NOTE

1. MATERIAL
CONTACT : BeCu 0.08t
HSG. : GLASS FILLED LCP UL94V-0
FINISH
CONTACT : ALL OVER ----- Ni UNDER 0.5µm THK. MIN.
SELECTIVE ----- Au PLATING 0.1µm THK. MIN.
OVER Pd-Ni PLATING.
SOLDER TAIL ---- TIN LEAD 2.5µm THK. MIN.
2. FOR MATING MALE CONN.(HDR./EJECTOR HDR.)
TO APPLY 68 POS. MALE CONN.(HDR./EJECTOR HDR.) BASED ON
JEIDA AND PCMCIA SPECIFICATION
3. GENERAL TOLERANCE : ±0.1
4. RECOMMENDED PWB THICKNESS : 0.16 TO 0.4



SECTION "C"-"C"

△ RECOMMENDED PWB FOOTPRINT LAYOUT

MATING FACE

SHEET INDEX	ISSUE	MAY		DR	DATE	CUSTOMER COPY
	SH NO.			ENGR	2/25/94	
TOLERANCES UNLESS OTHERWISE SPECIFIED		SEE NOTE 1	CHK	APPRO	DATE	
LINEAR		SEE NOTE 3			2/25/94	
ANGLES		SEE NOTE 1			2/25/94	

TITLE		IC CARD CONN.	
68POS. PL'G ASSY (OFFSET)			
SCALE	SIZE	DWG NO.	REV SHEET
5/1	C	90936	C 1 OF 1

BERG
ELECTRONICS